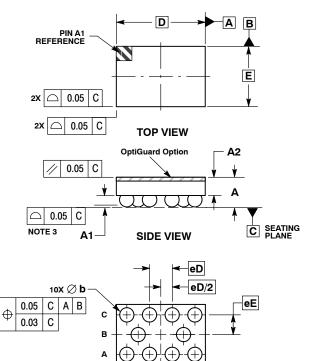




WLCSP10, 1.96x1.33 CASE 567BL ISSUE O

DATE 26 JUL 2010



BOTTOM VIEW

NOTES:

- NOTES:

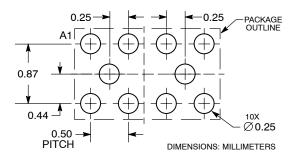
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

 2. CONTROLLING DIMENSION: MILLIMETERS.

 3. COPLANARITY APPLIES TO SPHERICAL CROWNS OF SOLDER BALLS.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.56	0.72	
A1	0.21	0.27	
A2	0.40 REF		
b	0.29	0.35	
D	1.96 BSC		
E	1.33 BSC		
eD	0.50 BSC		
еE	0 435 BSC		

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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